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Chip Ferrite Bead BLM18

1.Scope

This Reference Specification applies to Chip Ferrite Bead BLM18_ N Series.

2.Part Numbering

(ex.) <u>BL</u> <u>M</u> <u>18</u> <u>AG</u> <u>121</u> <u>S</u> <u>N</u> <u>1</u> <u>D</u> (1) (2) (3) (4) (5) (6) (7) (8) (9) (1)Product ID (2)Type (3)Dimension(L×W) (4)Characteristics (5)Typical Impedance at 100MHz (6)Performance (7)Category (8)Numbers of Circuit (9)Packaging(D:Taping / B:Bulk)

3.Rating

3.Rating								
		Impedance (Ω)		Rated		DC Resistance		
Customer	MURATA	(at 100MHz, Under Standard Testing Condition		Current (mA)			nax.)	
Part Number	Part Number	resung	Condition)	· · · ·	,	Initial Values	Values After	Remark
			Typical	at at 85°C 125°C		values	Testing	
				00 C	125 C		rooung	
	BLM18RK121SN1D	120±25%	120	20	00	0.25	0.35	
	BLM18RK121SN1B							
	BLM18RK221SN1D	220±25%	220	20	00	0.30	0.40	
	BLM18RK221SN1B							For
	BLM18RK471SN1D	470±25%	470	20	00	0.50	0.60	Digital
	BLM18RK471SN1B							Interface
	BLM18RK601SN1D	600±25%	600	20	00	0.60	0.70	
	BLM18RK601SN1B							
	BLM18RK102SN1D	1000±25%	1000	20	00	0.80	0.90	
	BLM18RK102SN1B			1			1	
	BLM18PG300SN1D	20 min.	30	10	00	0.05	0.10	
	BLM18PG300SN1B					0.00	0.10	
	BLM18PG330SN1D		33	3000*1	1000*1	0.025	0.050	
	BLM18PG330SN1B	0012070	00	0000		0.020	0.000	-
	BLM18PG600SN1D	40 min.	60	50	00	0.1	0.2	
	BLM18PG600SN1B		00	300	0.1	0.2		
	BLM18PG121SN1D	120±25%	120	2000*1	1000* ¹	0.05	0.10	
	BLM18PG121SN1B	12012070	120	2000 1000	0.00	0.10		
	BLM18PG181SN1D	180±25%	180	1500 ^{*1}	1000 ^{*1}	0.09	0.18	For DC power line
	BLM18PG181SN1B	10012070	100	1000	1000	0.00	0.10	
	BLM18PG221SN1D	220±25%	220	1400 ^{*1}	1000*1	0.10	0.14	
	BLM18PG221SN1B	22012070	220	1100	1000	0.10	0.14	
	BLM18PG331SN1D	330±25%	330	1200 ^{*1}	1000* ¹	0.15	0.20	
	BLM18PG331SN1B	000±2070	000	1200	1000	0.10	0.20	
	BLM18PG471SN1D	470±25%	470	10	00	0.20	0.26	
	BLM18PG471SN1B	470±2070	470	10	.00	0.20	0.20	
	BLM18KG221SN1D	220±25%	220	2200 *1	1000 ^{*1}	0.050	0.060	
	BLM18KG221SN1B	220 - 20 / 0	220	2200	1000	0.000	0.000	
	BLM18KG331SN1D	$330 \pm 25\%$	330	1700 ^{*1}	1000*1	0.080	0.095	
	BLM18KG331SN1B	000=2070	000	1700	1000	0.000	0.000	
	BLM18KG471SN1D	470±25%	470	1500 ^{*1}	1000* ¹	0.130	0.145	
	BLM18KG471SN1B					0.100	0.1.10	
	BLM18KG601SN1D	$600 \pm 25\%$	600	1300*1	1000* ¹	0.150	0.165	
	BLM18KG601SN1B					000	01100	
	BLM18AG121SN1D	120±25%	120 500		00	0.18	0.28	
	BLM18AG121SN1B	120120/0	120			0.10	0.20	Гал
	BLM18AG151SN1D	150+25%	150			0.25	0.25	For
	BLM18AG151SN1B	150±25%	150	C	00	0.25	0.35	general use
	BLM18AG221SN1D	220±25%	220	5	00	0.25	0.35	030
	BLM18AG221SN1B	220±23%	220	5	00	0.25	0.35	

Reference Only

Spec. No. JENF243A-0003W-01

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<u>opeo: No: 0EN12</u>	43A-0003VV-01						P.2/12	
		Impedance (Ω)				sistance		
		(at 100MHz, Under Sta	indard	Current	(Ω max.) Initial Values		[_]	
Customer	MURATA	Testing Co	ondition)	(mA)			Remark	
Part Number	Part Number			at at	Values	After		
			Typical	85°C 125°C		Testing		
	BLM18AG331SN1D			•				
	BLM18AG331SN1B	330±25%	330	500	0.30	0.40		
	BLM18AG471SN1D							
		470±25%	470	500	0.35	0.45	For	
	BLM18AG471SN1B						general	
	BLM18AG601SN1D	600±25%	600	500	0.38	0.48	use	
	BLM18AG601SN1B				0.00	01.10		
	BLM18AG102SN1D	1000±25%	1000	400	0.50	0.60		
	BLM18AG102SN1B	100012370	1000	400	0.50	0.00		
	BLM18BB050SN1D	F 05%	_	700	0.05	0.40		
	BLM18BB050SN1B	5±25%	5	700	0.05	0.10		
	BLM18BA050SN1D		_					
	BLM18BA050SN1B	5±25%	5	500	0.2	0.3		
	BLM18BB100SN1D							
		10±25%	10	700	0.10	0.20		
	BLM18BB100SN1B					<u> </u>		
	BLM18BA100SN1D	10±25%	10	500	0.25	0.35		
	BLM18BA100SN1B							
	BLM18BB220SN1D	22±25%	22	600	0.20	0.30		
	BLM18BB220SN1B	2222070			0.20	0.00		
	BLM18BA220SN1D	22±25%	22	500	0.35	0.45		
	BLM18BA220SN1B	22±2370	22	500	0.55	0.45		
	BLM18BB470SN1D	17.05%	47	550	0.05	0.05		
	BLM18BB470SN1B	47±25%	47	550	0.25	0.35		
	BLM18BD470SN1D							
	BLM18BD470SN1B	47±25%	47	500	0.3	0.4		
	BLM18BA470SN1D							
	BLM18BA470SN1B	47±25%	47	300	0.55	0.65		
	BLM18BB600SN1D							
		60±25%	60	550	0.25	0.35		
	BLM18BB600SN1B							
	BLM18BA750SN1D	75±25%	75	300	0.70	0.80		
	BLM18BA750SN1B						For	
	BLM18BB750SN1D	75±25%	75	500	0.30	0.40	high speed	
	BLM18BB750SN1B	1012070	10		0.00	0.10	signal line	
	BLM18BB121SN1D	120±25%	120	500	0.30	0.40	orgrida inte	
	BLM18BB121SN1B	12U±2J /0	120	500	0.30	0.40		
	BLM18BD121SN1D	100.050/	400	200	0.4	<u> </u>		
	BLM18BD121SN1B	120±25%	120	300	0.4	0.5		
	BLM18BA121SN1D	400 07-1						
	BLM18BA121SN1B	120±25%	120	200	0.9	1.0		
	BLM18BB141SN1D							
	BLM18BB141SN1B	140±25%	140	450	0.35	0.45		
	BLM18BB151SN1D							
		150±25%	150	450	0.37	0.47		
	BLM18BB151SN1B							
	BLM18BD151SN1D	150±25%	150	300	0.4	0.5		
	BLM18BD151SN1B							
	BLM18BB221SN1D	220±25%	220	450	0.45	0.55		
	BLM18BB221SN1B							
	BLM18BD221SN1D	220±25%	220	250	0.45	0.55		
	BLM18BD221SN1B	22012070	220	200	0.40	0.00		
	BLM18BB331SN1D	220 / 050/	220	400	0.50	0.00		
	BLM18BB331SN1B	330±25%	330	400	0.58	0.68		
	BLM18BD331SN1D	000 050		050	<u> </u>			
	BLM18BD331SN1B	330±25%	330	250	0.5	0.6		
	BLM18BD421SN1D			a				
	BLM18BD421SN1B	420±25%	420	250	0.55	0.65		
L			1	1	1	<u> </u>	1	

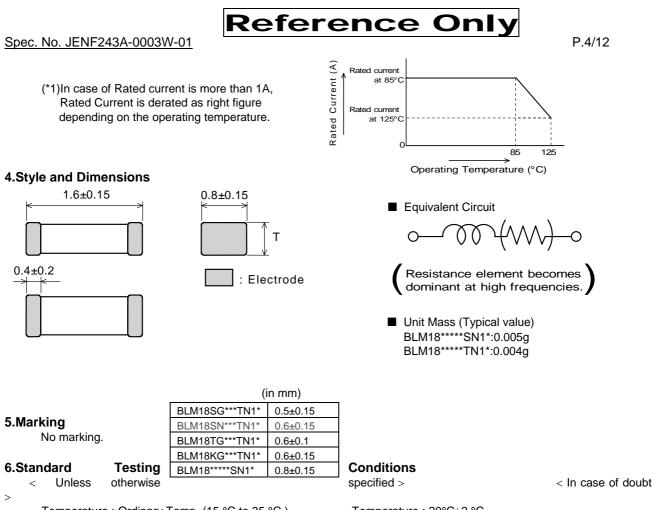
MURATA MFG.CO., LTD.



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Spec. No. JENF243A-0003W-01								
Customer		$\begin{array}{c c} Impedance (\Omega) & Rated & DC Resistance \\ (at 100MHz, Under Standard & Current & (\Omega max.) \end{array}$						
Customer Part Number	MURATA Part Number	Testing Co	esting Condition) (mA)		Initial	Values	Remark	
Fait Number	Fait Number		Typical	at 85°C	at 125°C	Values	After Testing	
	BLM18BB471SN1D							
	BLM18BB471SN1B	470±25%	470	3	00	0.85	0.95	
	BLM18BD471SN1D			-				
	BLM18BD471SN1B	470±25%	470	2	50	0.55	0.65	
	BLM18BD601SN1D			-	~ ~			
	BLM18BD601SN1B	600±25%	600	2	00	0.65	0.75	
	BLM18BD102SN1D	1000 0701			~~			
	BLM18BD102SN1B	1000±25%	1000	2	00	0.85	0.95	For
	BLM18BD152SN1D							high speed
	BLM18BD152SN1B	1500±25%	1500	1	50	1.2	1.3	signal line
	BLM18BD182SN1D							
	BLM18BD182SN1B	1800±25%	1800	1	50	1.5	1.6	
	BLM18BD222SN1D							
	BLM18BD222SN1B	2200±25%	2200	1	50	1.5	1.6	
	BLM18BD252SN1D							-
	BLM18BD252SN1B	2500±25%	2500	150		1.5	1.6	
	BLM18TG121TN1D							1
	BLM18TG121TN1B	120±25%	120	200		0.25	0.3	For
	BLM18TG221TN1D							
	BLM18TG221TN1B	220±25%	220	2	00	0.3	0.4	general
	BLM18TG601TN1D							use
	BLM18TG601TN1B	600±25%	600			0.45	0.6	(Thin type)
	BLM18TG102TN1D							())))
	BLM18TG102TN1B	1000±25%	1000			0.6	0.8	
	BLM18SG260TN1D			. 4				
	BLM18SG260TN1B	$26 \pm 25\%$	26	6000 *1	1000*1	0.007	0.012	
	BLM18SG700TN1D							
	BLM18SG700TN1B	$70 \pm 25\%$	70	4000*1	1000*1	0.020	0.030	
	BLM18SG121TN1D							
	BLM18SG121TN1B	$120 \pm 25\%$	120	3000*1	1000 ^{*1}	0.025	0.035	
	BLM18SG221TN1D							
	BLM18SG221TN1B	$220 \pm 25\%$	220	2500 ^{*1}	1000 ^{*1}	0.040	0.055	
	BLM18SG331TN1D	000 1 050/		4500*1				
	BLM18SG331TN1B	$330 \pm 25\%$	330	1500 ^{*1}	1000*1	0.070	0.085	
	BLM18SN220TN1D			0000*1	5000 *1			For DC
	BLM18SN220TN1B	22±7	22	8000*1	5000*1	0.004	0.005	power line
	BLM18KG260TN1D			0000*1	4000*1			(Thin type)
	BLM18KG260TN1B	26±25%	26	6000 ^{*1}	1000*1	0.007	0.012	
	BLM18KG300TN1D		20	FOO *1	4000*1	0.010	0.045	
	BLM18KG300TN1B	$30 \pm 25\%$	30	5000*1	1000*1	0.010	0.015	
	BLM18KG700TN1D	70±25%	70	70 3500 ^{*1} 1000 ^{*1}		0.022	0.022	
	BLM18KG700TN1B	10-23%	70	3500	1000	0.022	0.032	
	BLM18KG101TN1D	$100 \pm 25\%$	100	3000*1	1000*1	0.030	0.040	
	BLM18KG101TN1B	100-20%	100	3000	3000 ^{*1} 1000 ^{*1}	0.030	0.040	
	BLM18KG121TN1D		120	3000*1	1000* ¹	0.030	0.040	
	BLM18KG121TN1B	120 - 20 /0	120	0000	1000	0.000	0.040	

• Operating Temperature : -55°C to +125°C • Storage Temperature : -55°C to +125°C



Temperature : Ordinary Temp. (15 °C to 35 °C) Humidity : Ordinary Humidity (25%(RH) to 85%(RH)) Temperature : 20°C±2 °C Humidity : 60%(RH) to 70%(RH) Atmospheric pressure : 86kPa to 106kPa

7.Specifications

7-1.Electrical Performance

No.	Item	Specification	Test Method
7-1-1	Impedance	Meet item 3.	Measuring Frequency : 100MHz±1MHz Measuring Equipment : Agilent 4291A or the equivalent Test Fixture : Agilent 16192A or the equivalent
7-1-2	DC Resistance	Meet item 3.	Measuring Equipment : Digital multi meter For BLM18SN_TN Measuring Equipment : YOKOGAWA 755611 or the equivalent Test Fixture : Agilent 16044A or the equivalent * Except resistance of the Substrate and Wire



7-2.Mechanical Performance

No.	echanical Pe Item	Specification	Test Method			
7-2-1	Appearance and	Meet item 4.	Visual Inspection and measured with Slide Calipers.			
	and Dimensions Bonding Strength Bending Strength	Meet Table 1. <u>Table 1</u> <u>Appearance</u> No damage Impedance Within ±30% Change (for (at 100MHz) BLM18SN Within ±50%) DC Resistance Meet item 3.	R0.5 Substrate It shall be soldered on the substrate. Substrate: Glass-epoxy 100mm×40mm×1.6mm Deflection : 1.0mm Speed of Applying Force : 0.5mm/s Pressure jig Keeping Time : 30s			
7-2-4	Vibration		It shall be soldered on the substrate. Oscillation Frequency : 10Hz to 55Hz to 10Hz for 1 min Total Amplitude : 1.5mm Testing Time : A period of 2 hours in each of 3 mutually			
7-2-5	Resistance to Soldering Heat	Meet Table 2. <u>Table 2</u> <u>Appearance</u> No damage Impedance Within ±30% (for BLM18K0 (at 100MHz) Within ±40%) (for BLM18S1 Within ±50% DC Resistance Meet item 3.	Then measured after exposure in the room condition for 48h±4h.			
7-2-6	Drop	Products shall be no failur after tested.	e It shall be dropped on concrete or steel board. Method : free fall Height : 75cm Attitude from which the product is dropped : 3 direction The number of times : 3 times for each direction(Total 9 times)			
7-2-7	Solderability	The electrodes shall be a least 95% covered with new solder coating.	t Flux : Ethanol solution of rosin,25(wt)%			



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7-3. Environmental Performance

It shall be soldered on the substrate.

No.	Item	Specifi	ication	Test Method
7-3-1	Temperature Cycle	Table 3 Appearance Impedance Change (at 100MHz)	No damage Within ±30% (for BLM18KG Within-10%to +50%) (for BLM18SN Within ±50%) Meet item 3.	1 cycle: 1 step:-55 °C(+0 °C,-3 °C) / 30min±3min 2 step:Ordinary temp. / 10min to 15min 3 step:+125 °C(+3 °C,-0 °C) / 30min±3min 4 step: Ordinary temp. / 10min to 15min Total of 100 cycles Then measured after exposure in the room condition for 48h±4h.
7-3-2	Humidity	Meet Table 1.		Temperature : 40°C±2°C Humidity : 90%(RH) to 95%(RH) Time : 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.
7-3-3	Heat Life			Temperature : 125°C±3°C (in case of Rated current is more than 1A, do the test at : +85 °C±3°C) Applying Current : Rated Current Time : 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.
7-3-4	Cold Resistance			Temperature : -55±2°C Time : 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.

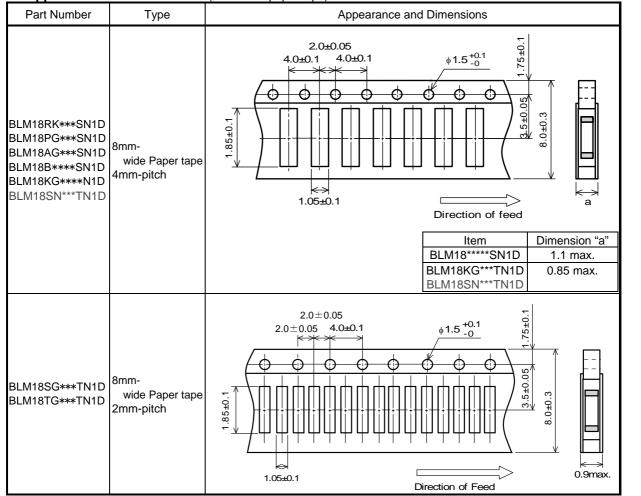


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(in mm)

8.Specification of Packaging

8-1. Appearance and Dimensions (8mm-wide paper tape)



(1) Taping

Products shall be packaged in the cavity of the base tape continuously and sealed by top tape and bottom tape.

- (2) Sprocket hole: The sprocket holes are to the right as the tape is pulled toward the user.
- (3) Spliced point: The base tape and top tape have no spliced point
- (4) Cavity: There shall not be burr in the cavity.
- (5) Missing components number

Missing components number within 0.1% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

8-2.Tape Strength

(1)Pull Strength

	Top tape	5N min			
	Bottom tape	nin nc			

(2)Peeling off force of Top tape 0.1N to 0.6N (Minimum value is typical.) *Speed of Peeling off:300mm/min

165 to 180 degree	Top tape
Bottom tape	Base tape

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8-3. Taping Condition

(1)Standard quantity per reel

Туре	Quantity per 180mm reel			
BLM18(except BLM18SG/BLM18TG)	4000 pcs. / reel			
BLM18SG/BLM18TG	10000 pcs. / reel			

(2)There shall be leader-tape (top tape and empty tape) and trailer- tape (empty tape) as follows.(3)On paper tape, the top tape and the base tape shall not be adhered at the tip of the empty leader tape for more than 5 pitch.

(4)Marking for reel

The following items shall be marked on a label and the label is stuck on the reel. (Customer part number, MURATA part number, Inspection number(*1), RoHS Marking(*2), Quantity, etc) *1) « Expression of Inspection No. » $\Box \Box \\ (1) \quad OOOO \\ (2) \quad X \times X \\ (3) \quad (3$

(3) Serial No.

*2) « Expression of RoHS Marking » ROHS – $\underline{Y} (\Delta)$ (1) (2)

(1) RoHS regulation conformity parts.

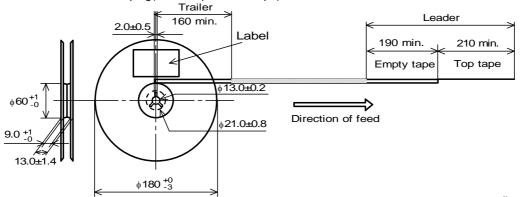
(2) MURATA classification number

(5)Outside package

These reels shall be packed in the corrugated cardboard package and the following items shall be marked on a label and the label is stuck on the box.

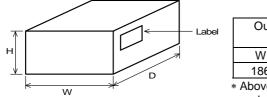
(Customer name, Purchasing order number, Customer part number, MURATA part number, RoHS discrimination(*2), Quantity, etc)

(6) Dimensions of reel and taping (leader-tape, trailer-tape)

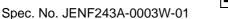


(in mm)

8-4. Specification of Outer Case



bel	Outer Case Dimensions (mm)			Standard Reel Quantity in Outer Case (Reel)			
	W	W D H		(Reei)			
	186	186	93	5			
3	Above O order.	uter Case	size is ty	pical. It depends on a quantity of an			





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9. 🕂 Caution

9-1.Surge current

Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise. Please contact us in advance in case of applying the surge current.

9-2.Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment (6) Disaster prevention / crime prevention equipment
- (2) Aerospace equipment (7
- (3) Undersea equipment
- (7) Traffic signal equipment
- (8) Transportation equipment (vehicles, trains, ships, etc.)
- (4) Power plant control equipment
- (5) Medical equipment
- (9) Applications of similar complexity and /or reliability requirements to the applications listed in the above

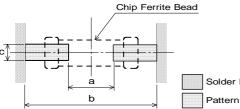
10. Notice

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

10-1.Land pattern designing

- Standard land dimensions
- < For BLM18 series (except BLM18PG/BLM18SG/BLM18KG/ BLM18SN type) >

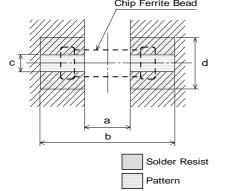


Туре	Soldering	а	b	С
BLM18 (except18PG/18SG/	Flow	0.7	2.2 to 2.6	07
BLM18KG/18SN type)	Reflow	0.7	1.8 to 2.0	0.7

Solder Resist

(in mm)





	Rated				Land pad thickness			
Туре	Current	а	b	С	and dimension d			
	(A)				18µm	35µm	70µm	
	0.5 to 1.5		Flow		0.7	0.7	0.7	
BLM18PG BLM18SG	1.7 to 2.5	07	2.2 to 2.6	0.7	1.2	0.7	0.7	
BLM18KG	3 to 4	0.7	Reflow	0.7	2.4	1.2	0.7	
BLIVITORG	5 to 6		1.8 to 2.0		6.4	3.3	1.65	
BLM18SN	8	0.7	2.0	0.7	-	6.4	3.3	

(in mm)

*The excessive heat by land pads may cause deterioration at joint of products with substrate.

10-2.Soldering Conditions

Products can be applied to reflow and flow soldering.

(1) Flux,Solder

• /				
	Flux	Use rosin-based flux, but not highly acidic flux (with chlorine content exceeding 0.2(wt)%.)		
		Do not use water-soluble flux.		
	Solder	Use Sn-3.0Ag-0.5Cu solder		
		Standard thickness of solder paste : 100 µm to 200 µm		

(2) Soldering conditions

• Pre-heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the ferrite, resulting in the deterioration of product quality.

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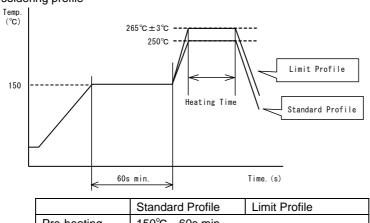
Spec. No. JENF243A-0003W-01

• Standard soldering profile and the limit soldering profile is as follows. The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.

Reference Only

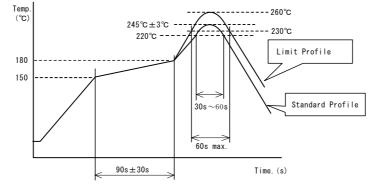
(3)soldering profile





	Standard Profile	Limit Prome
Pre-heating	150°C、60s min.	
Heating	250°C、4∼6s	265°C±3°C、5s max.
Cycle of flow	2 times	2 times

□Reflow soldering profile



	Standard Profile	Limit Profile
Pre-heating	150~180°C、90s±30s	
Heating	above 220°C、30s~60s	above 230°C、60s max.
Peak temperature	245±3°C	260°C,10s
Cycle of reflow	2 times	2 times

10-3. Reworking with soldering iron

- Pre-heating: 150°C, 1 min
 Tip temperature: 350°C max.
- Soldering iron output: 80W max.
- Tip diameter: φ 3mm max.
- Soldering time : 3(+1,-0) seconds. Times : 2times max.

Note :Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.



Spec. No. JENF243A-0003W-01 10-4.Solder Volume

Solder shall be used not to be exceeded as shown below.

1/3T≦t≦T (T: Chip thickness)

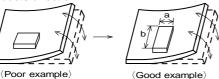
Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

10-5. Attention regarding P.C.B. bending

The following shall be considered when designing and laying out P.C.B.'s.

Upper Limit

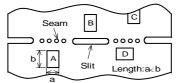
(1) P.C.B. shall be designed so that products are not subject to the mechanical stress for board warpage. <Products direction>



Products shall be located in the sideways direction (Length: a<b) to the mechanical stress.

(2)Products location on P.C.B. separation.

Products (A, B, C, D) shall be located carefully so that products are not subject to the mechanical stress due to warping the board. Because they may be subjected the mechanical stress in order of $A>C>B \cong D$.



10-6.Mounting density

Add special attention to radiating heat of products when mounting the inductor near the products with heating. The excessive heat by other products may cause deterioration at joint of this product with substrate.

10-7. Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance of the Ferrite material and/or corrosion of Inner Electrode may result from the use.

- (1) in the corrodible atmosphere (acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc.)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products
- (3) in the atmosphere where the temperature / humidity changes rapidly and it is easy to dew

10-8. Resin coating

The impedance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin. In prior to use, please make the reliability evaluation with the product mounted in your application set.

10-9.Cleaning Conditions

Products shall be cleaned on the following conditions.

(1)Cleaning temperature shall be limited to 60°C max. (40°C max. for IPA.)

(2)Ultrasonic cleaning shall comply with the following conditions, avoiding the resonance phenomenon

at the mounted products and P.C.B.

Power:20W/ℓ max. Frequency:28kHz to 40kHz Time:5 min max.

(3)Cleaner

1.Alternative cleaner

Isopropyl alcohol (IPA)

2.Aqueous agent

PINE ALPHA ST-100S

(4) There shall be no residual flux and residual cleaner after cleaning.

In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.

(5)Other cleaning

Please contact us.

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10-10. Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.



10-11.Storage Conditions

(1)Storage period

Use the products within 6 months after delivered.

Solderability should be checked if this period is exceeded.

- (2)Storage conditions
 - Products should be stored in the warehouse on the following conditions.
 - Temperature : -10°C to 40°C
 - Humidity : 15% to 85% relative humidity
 - No rapid change on temperature and humidity
 - Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
 - Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
 - Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
 - Products should be stored under the airtight packaged condition.

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

11 . 🗥 Note

- (1)Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2)You are requested not to use our product deviating from the reference specifications.
- (3)The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.